

SHENZHEN MENGKE ELECTRONICS TECHNOLOGY CO.,LTD TO-252 / 251 Plastic-Encapsulate MOSFETS

MK5003N

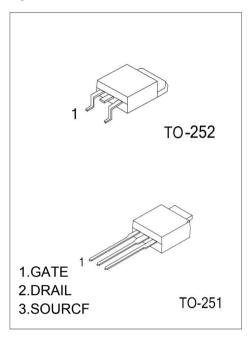
N-Channel 30-V(D-S) Power MOSFET

V(BR)DSS	RDS(on)MAX	ID
30 V	12mΩ @ 10 V	50A
30 V	18mΩ @ 4.5 V	SUA

General Description:

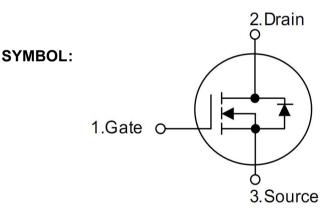
The high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition , this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes . The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power suppliers, converters and PWM motor controls , these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

Equivalent Circuit:



FEATURE:

- Power switching application
- * Hard switched and high frequency circuits
- ※ Uninterruptible power supply
- Fully characterized avalanche voltage and current
- ※ Excellent package for good heat dissipation
- Good stability and uniformity with high EAS



Maximum ratings (Ta=25[°]C unless otherwise noted)

Parameter	Symbol	Value	Unit	
Drain-Source Voltage	VDS	30	V	
Gate-Source Voltage	VGS	±20	V	
Continuous Drain Current	ID 50		^	
Pulsed Diode Curren	IDM	170	A	
Power Dissipation	PD	50	W	
Thermal Resistance from Junction to Ambient (t≤10s)	RθJA	100	°C/W	
Operating Junction	TJ	150	%	
Storage Temperature	TSTG	-55~+150	°C	



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MOSFET ELECTRICAL CHARACTERISTICS

Static Electrical Characteristics (Ta = 25 $^{\circ}$ C Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Static	•				•	•
Drain-source breakdown voltage	V(BR)DSS	VGS = 0V, ID = 250μA	30			V
Gate-source threshold voltage	VGS(th)	VDS =VGS, ID = 250μA	1		2.5	V
Gate-source leakage	IGSS	VDS =0V, VGS = ±20V			±100	nA
Zero gate voltage drain current	IDSS	VDS = 30V, VGS =0V			1	μA
Duning any superior and a section and a	RDS(on)	VGS = 10V, ID = 25A		7.3	12	mΩ
Drain-source on-state resistancea	RDS(on)	VGS = 4.5V, ID = 20A		9.3	18	mΩ
Forward transconductancea	gfs	VDS = 25V, ID = 15A		28		S
Diode forward voltage	VSD	IS= 15A, VGS=0V		0.85	1.4	V
Dynamic					•	
Input capacitance	Ciss	VDS = 15V,VGS =0V, f=1MHz		610		pF
Output capacitance	Coss			300		pF
Reverse transfer capacitanceb	Crss			125		pF
Total gate charge	Qg			15		nC
Gate-source charge	Qgs	VDS = 15V,VGS = 10V, ID = 30A		1.9		nC
Gate-drain charge	Qgd	15 00/1		3.9		nC
Switchingb	•				•	•
Turn-on delay time	td(on)			8		ns
Rise time	tr	VDS= 15V		84		ns
Turn-off delay time	td(off)	RL= 6Ω , ID = 20A, VGEN= 10V,Rg= 3Ω		15		ns
Fall time	tf			10		ns
Drain-Source Diode Characteris	stics			•	•	•
Continuous Source-Drain Diode Current	IS				30	Α
Pulsed Diode forward Curren	ISM				170	Α

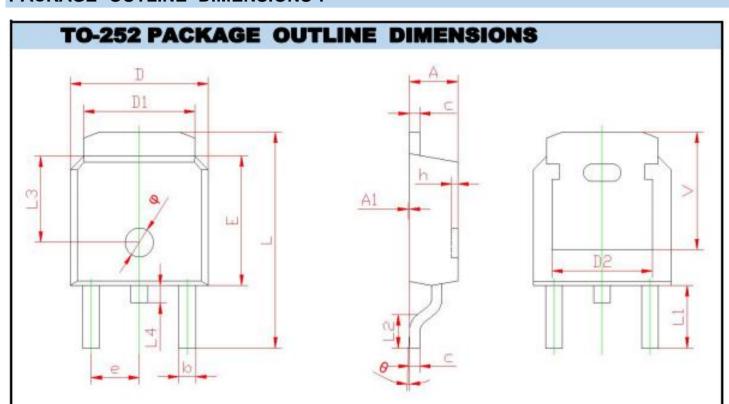
Note:

- 1. Repetitive Rating : Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t < 10 sec.
- 3. Pulse Test : Pulse Width≤300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production testing.



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PACKAGE OUTLINE DIMENSIONS:

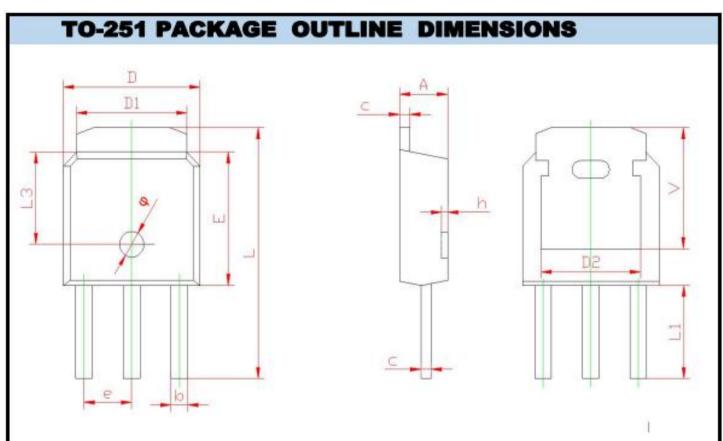


C b.a.l	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.800 REF		0.189	REF	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 REF		0.114	4 REF	
L2	1.400	1.700	0.055	0.067	
L3	4.00	4.00 REF		7 REF	
L4	0.600	1.000	0.024	0.039	
φ	1.200	1.400	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.500 REF		0.217	7 REF	



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D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.800 REF		0.189 REF	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	4.30	0 REF	0.170	REF
L3	4.00 REF		0.16 REF	
L4	0.600	1.000	0.024	0.039
h	0.000	0.300	0.000	0.012
V	5.500 REF		0.217	7 REF